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# Single P-Channel PowerTrench<sup>®</sup> MOSFET $-20V, -7.8A, 30m\Omega$

### Features

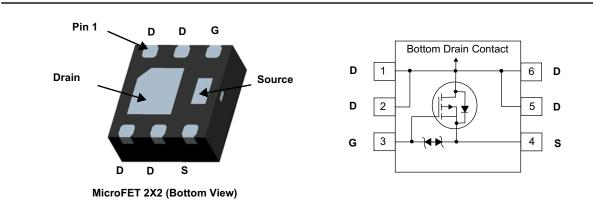
- Max  $r_{DS(on)}$  = 30m $\Omega$  at V<sub>GS</sub> = -4.5V, I<sub>D</sub> = -7.8A
- Max  $r_{DS(on)}$  = 37m $\Omega$  at V<sub>GS</sub> = -2.5V, I<sub>D</sub> = -6.6A
- Max  $r_{DS(on)}$  = 50m $\Omega$  at V<sub>GS</sub> = -1.8V, I<sub>D</sub> = -5.5A
- Max  $r_{DS(on)}$  = 90m $\Omega$  at V<sub>GS</sub> = -1.5V, I<sub>D</sub> = -2.0A
- Low profile 0.8mm maximum in the new package MicroFET 2X2 mm
- HBM ESD protection level > 3KV typical (Note 3)
- Free from halogenated compounds and antimony oxides
- RoHS Compliant



# **General Description**

This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



# **MOSFET Maximum Ratings** $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage	-20	V	
V <sub>GS</sub>	Gate to Source Voltage		±8	V
	Drain Current -Continuous	(Note 1a)	-7.8	
ID	-Pulsed		-24	— A
D	Power Dissipation	(Note 1a)	2.4	w
P <sub>D</sub>	Power Dissipation	(Note 1b)	0.9	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

# **Thermal Characteristics**

R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient	(Note 1a)	52	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	145	0,00

#### Package Marking and Ordering Information

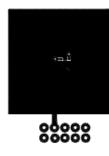
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
510	FDMA510PZ	MicroFET 2X2	7"	8mm	3000units

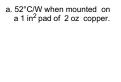
FDMA510PZ
Single
P-Channel
PowerTrench <sup>®</sup>
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250μA, V <sub>GS</sub> = 0V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to $25^{\circ}C$		-13		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16V, V_{GS} = 0V$			-1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 8V, V_{DS} = 0V$			±10	μΑ
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = -250 \mu A$	-0.4	-0.7	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu A$ , referenced to 25°C		3		mV/°C
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -7.8A		27	30	
		$V_{GS} = -2.5V, I_D = -6.6A$		34	37	mΩ
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -5.5A		46	50	
		$V_{GS} = -1.5V$ , $I_{D} = -2.0A$		60	90	
		$V_{GS} = -4.5V, I_D = -7.8A, T_J = 125^{\circ}C$ 36		40	1	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = -5V, I_D = -7.8A$		26		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1110	1480	pF
C <sub>oss</sub>	Output Capacitance	──V <sub>DS</sub> = −10V, V <sub>GS</sub> = 0V, f = 1MHz		205	275	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			185	280	pF
Switching	g Characteristics				•	
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = -10V, I_D = -7.8A$ $V_{GS} = -4.5V, R_{GEN} = 6\Omega$		7	14	ns
t <sub>r</sub>	Rise Time			9	18	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = -4.5V, R_{GEN} = 602$		125	200	ns
t <sub>f</sub>	Fall Time			64	103	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DD} = -5V, I_D = -7.8A$ $V_{GS} = -4.5V$		19	27	nC
Q <sub>gs</sub>	Gate to Source Charge			2.1		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			4.2		nC
Drain-Sou	urce Diode Characteristics					
	Maximum Continuous Drain-Source Dio	de Forward Current			-2	A
0				1		

$I_{\rm F} = -7.8$ A, di/dt = 100A/µs	I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				-2	Α
$I_F = -7.8A$ , di/dt = 100A/µs	V <sub>SD</sub>	Source to Drain Diode Forward Voltage $V_{GS} = 0V$ , $I_S = -2A$			-0.8	-1.2	V
	t <sub>rr</sub>	Reverse Recovery Time	L = 7.84 di/dt = 1004/		66	106	ns
	Q <sub>rr</sub>	Reverse Recovery Charge	F = -7.8A, di/dt = 100A/µs		44	71	nC

Notes: 1.  $R_{\theta JA}$  is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



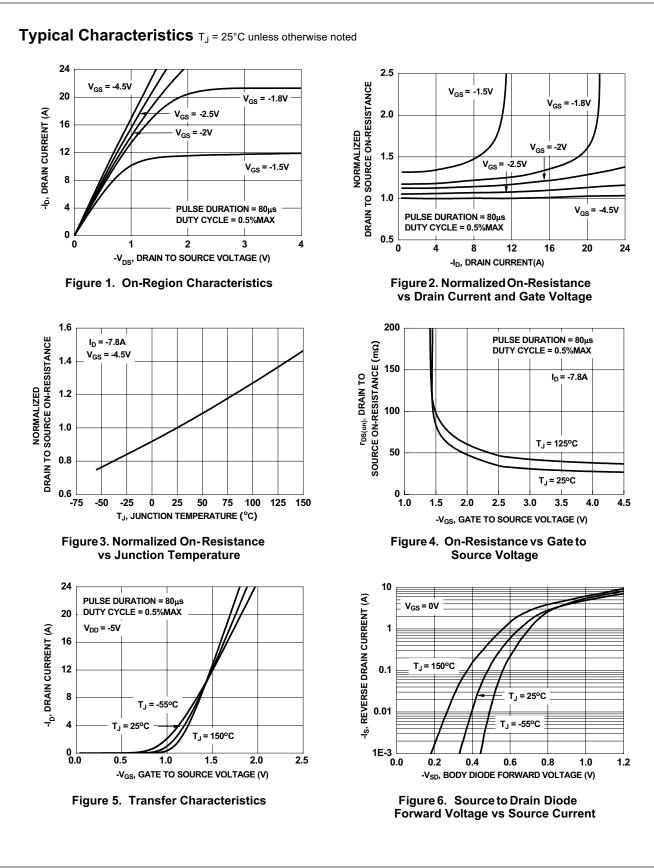


b. 145°C/W when mounted on a minimum pad of 2 oz copper.

Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.</li>
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

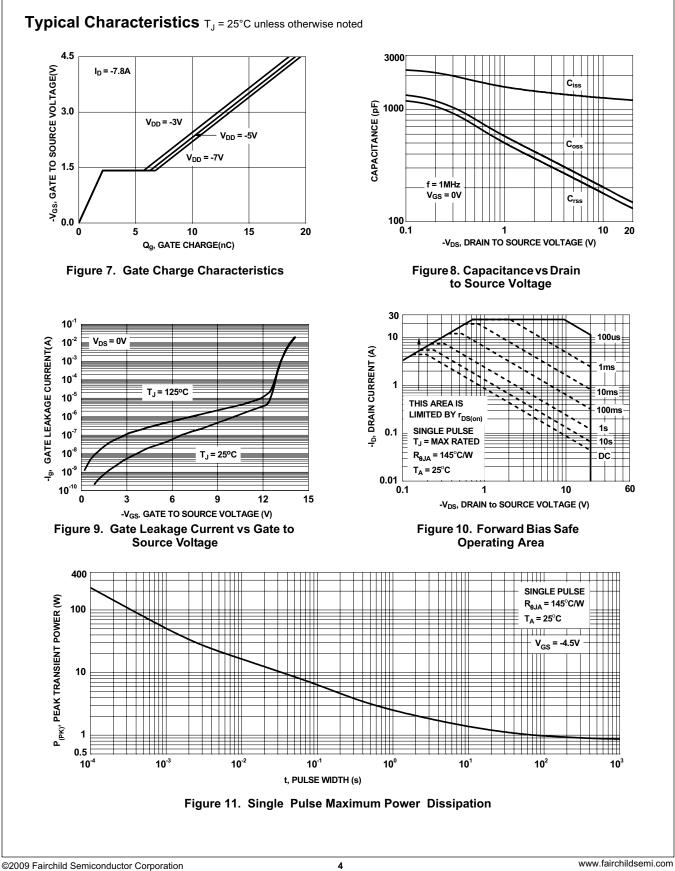
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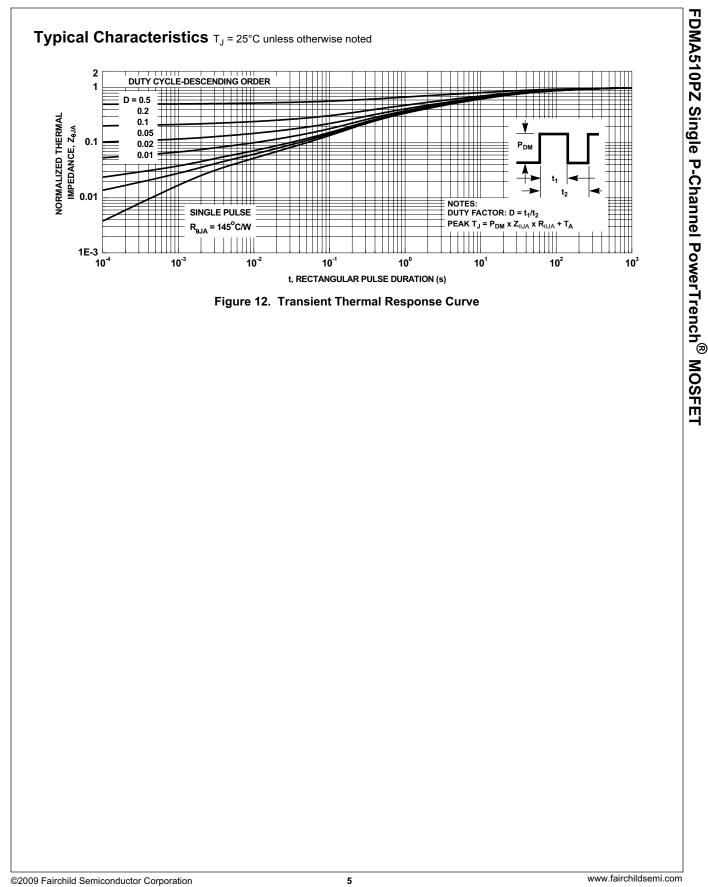
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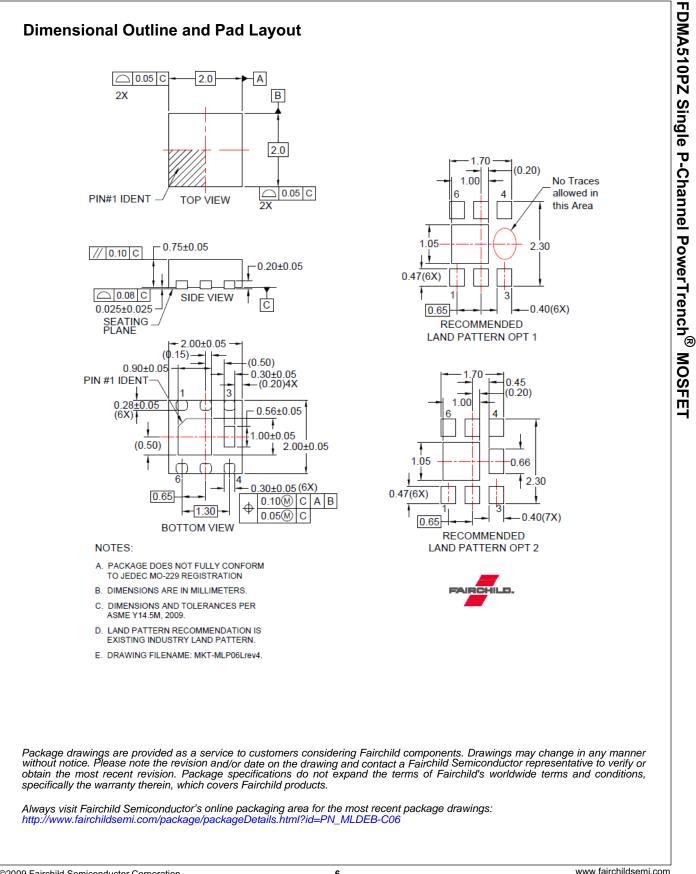


FDMA510PZ Single P-Channel PowerTrench<sup>®</sup> MOSFET

FDMA510PZ Rev.B3



FDMA510PZ Rev.B3



MOSFET



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